

N-channel 60V,20A, TO-252 Power MOSFET 功率場效應管

■Features 特點

Low on-resistance 低導通電阻

Maximum DC current capability 最大直流電流能力

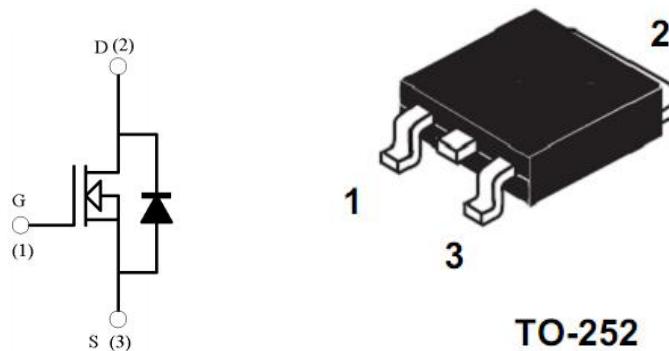
$R_{DS(ON)} \text{ TYP } 37 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$

■Applications 應用

Power Switching Application 開關電源應用

Uninterruptible power supply 不間斷電源

■Internal Schematic Diagram 內部結構



■Absolute Maximum Ratings 最大額定值

Characteristic 特性參數	Symbol 符號	Rating 頓定值	Unit 單位
Drain-Source Voltage 漏極-源極電壓	BV_{DSS}	60	V
Gate- Source Voltage 柄極-源極電壓	V_{GS}	± 20	V
Drain Current (continuous)漏極電流-連續	I_D (at $T_C = 25^\circ\text{C}$)	20	A
Drain Current (pulsed)漏極電流-脉冲	I_{DM}	60	A
Total Device Dissipation 總耗散功率	P_{TOT} (at $T_C = 25^\circ\text{C}$)	40	W
Avalanche energy, single pulsed 雪崩能量	EAS	72	mJ
Thermal Resistance Junction to Case 烘阻	$R_{\Theta JC}$	3.3	$^\circ\text{C}/\text{W}$
Junction/Storage Temperature 結溫/儲存溫度	T_J, T_{stg}	-55~150	$^\circ\text{C}$

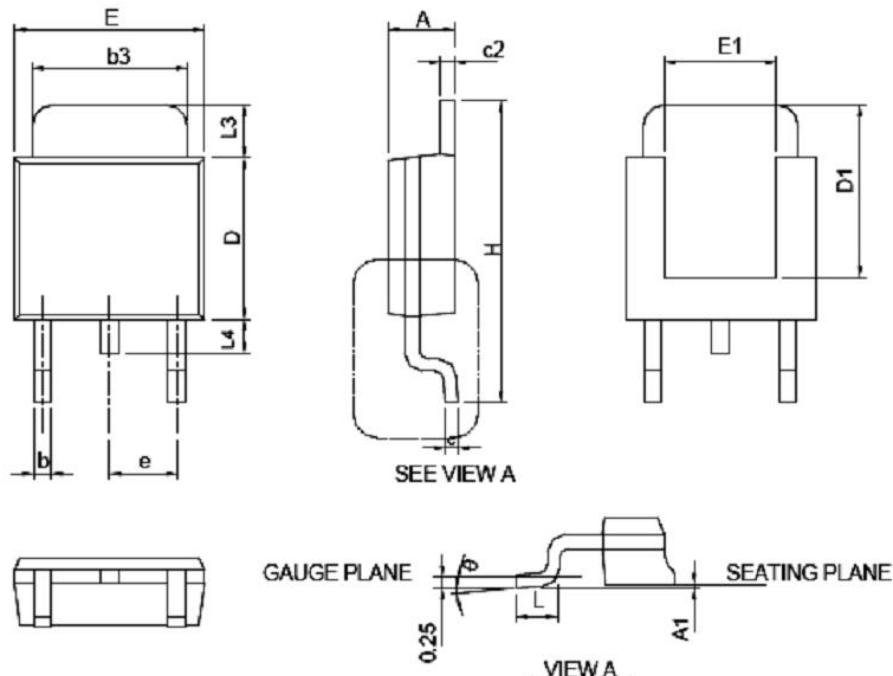
E A S c o n d i t i o n : $T_J = 25^\circ\text{C}$, $V_{DD} = 30\text{ V}$, $L = 0.5\text{ mH}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

■ Electrical Characteristics 電特性

($T_A=25^\circ\text{C}$ unless otherwise noted 如無特殊說明，溫度為 25°C)

Characteristic 特性參數	Symbol 符號	Min 最小值	Typ 典型值	Max 最大值	Unit 單位
Drain-Source Breakdown Voltage 漏極-源極擊穿電壓($I_D=250\mu\text{A}, V_{GS}=0\text{V}$)	BV_{DSS}	60	—	—	V
Gate Threshold Voltage 柵極開启電壓($I_D=250\mu\text{A}, V_{GS}=V_{DS}$)	$V_{GS(\text{th})}$	1	2	3	V
Zero Gate Voltage Drain Current 零柵壓漏極電流($V_{GS}=0\text{V}, V_{DS}=60\text{V}$)	I_{DSS}	—	—	1	μA
Gate Body Leakage 柵極漏電流($V_{GS}=\pm20\text{V}, V_{DS}=0\text{V}$)	I_{GSS}	—	—	±100	nA
Static Drain-Source On-State Resistance 靜態漏源導通電阻($I_D=20\text{A}, V_{GS}=10\text{V}$)	$R_{DS(\text{ON})}$	—	37	45	$\text{m}\Omega$
Diode Forward Voltage Drop 內附二極管正向壓降($I_{SD}=20\text{A}, V_{GS}=0\text{V}$)	V_{SD}	—	—	1.2	V
Input Capacitance 輸入電容 ($V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$)	C_{ISS}	—	550	—	pF
Common Source Output Capacitance 共源輸出電容($V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$)	C_{OSS}	—	60	—	pF
Reverse Transfer Capacitance 反向傳輸電容 ($V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$)	C_{RSS}	—	25	—	pF
Total Gate Charge 總柵極電荷密度 ($V_{DS}=48\text{V}, I_D=15\text{A}, V_{GS}=10\text{V}$)	Q_g	—	12	—	nC
Gate Source Charge 柵源電荷密度 ($V_{DS}=48\text{V}, I_D=15\text{A}, V_{GS}=10\text{V}$)	Q_{gs}	—	4	—	nC
Gate Drain Charge 柵漏電荷密度 ($V_{DS}=48\text{V}, I_D=15\text{A}, V_{GS}=10\text{V}$)	Q_{gd}	—	5	—	nC
Turn-On Delay Time 開啟延遲時間 ($V_{DS}=30\text{V}, I_D=2\text{A}, R_{\text{GEN}}=3\Omega, V_{GS}=10\text{V}$)	$t_{d(\text{on})}$	—	5	—	ns
Turn-On Rise Time 開啟上升時間 ($V_{DS}=30\text{V}, I_D=2\text{A}, R_{\text{GEN}}=3\Omega, V_{GS}=10\text{V}$)	t_r	—	3	—	ns
Turn-Off Delay Time 關斷延遲時間 ($V_{DS}=30\text{V}, I_D=2\text{A}, R_{\text{GEN}}=3\Omega, V_{GS}=10\text{V}$)	$t_{d(\text{off})}$	—	16	—	ns
Turn-On Fall Time 開啟下降時間 ($V_{DS}=30\text{V}, I_D=2\text{A}, R_{\text{GEN}}=3\Omega, V_{GS}=10\text{V}$)	t_f	—	2	—	ns

■DIMENSION 外形封裝尺寸



SYMBOL	TO-252			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1		0.13		0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4		1.02		0.040
O	0°	8°	0°	8°